Additive Manufacturing Systems

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P.O. Box 1450
Alexandria, VA 22313-1450

PATENT APPLICATION

on October 21, 2003.

Jeffrey D. Myers, Reg. No. 35,964

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.

09/841,871

Applicant

David M. Keicher, et al.

Filed

April 24, 2001

Title

MULTIPLE BEAMS AND NOZZLES TO INCREASE DEPOSITION RATE

TC/A.U.

1762

Examiner

FULLER, ERIC B.

Docket No.

ODC1120-DIVA

Commissioner for Patents United States Patent and Trademark Office PO Box 1450 Alexandria, Virginia 22313-1450

## DECLARATION OF DAVID M. KEICHER UNDER 37 C.F.R. § 1.131

Sir:

## DAVID M. KEICHER declares as follows:

- 1. I am an inventor of the subject matter of the above-identified patent application.
- 2. I and my co-inventor conceived and invented the inventive subject matter disclosed and claimed in the above-identified patent application prior to September 12, 1997. To wit, we conceived how to create an apparatus and method for direct material deposition having a laser nozzle assembly with multiple laser beams coupled with separate powdered material streams, positioning a substrate adjacent to the laser nozzle assembly, heating the

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powdered material with the laser beams, and providing relative motion between the assembly and the substrate.

3. After September 12, 1997, I prepared drawings of the invention and diligently assisted in the preparation of a patent application, which was filed on January 22, 1998.

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the above-referenced application or any patent issuing thereon.

Date: 10/21/03

DAVID M. KEICHER

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